FCA76N60N N-Channel MOSFET 600V, 76A, 36mΩ

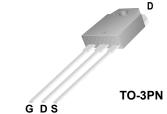
Features

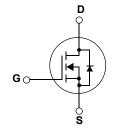
- $R_{DS(on)}$ = 28m Ω (Typ.)@ V_{GS} = 10V, I_D = 38A
- Ultra Low Gate Charge (Typ. Qg = 218nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant

Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		Parameter			Units	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Gate to Source Voltage		±30	V		
I _D	Droin Current	-Continuous (T _C = 25 ^o C)		76	٨	
	Drain Current	-Continuous ($T_C = 100^{\circ}C$)		48.1	- A	
I _{DM}	Drain Current	-Pulsed (Note 1)		228	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		8022	mJ		
I _{AR}	Avalanche Current		25.3	А		
E _{AR}	Repetitive Avalanche Energy		5.43	mJ		
dv/dt MOSFET dv/dt Ruggedness Peak Diode Recovery dv/dt		(Note 3)		100	- V/ns	
				20	- V/IIS	
P _D	Dewer Dissinction	(T _C = 25 ^o C)		543	W	
	Power Dissipation	-Derate above 25°C		4.34	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C		
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	Ratings	Units
R _{0JC} Thermal Resistance, Junction to Case		0.23	
$R_{ ext{ heta}JS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.24	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	40	

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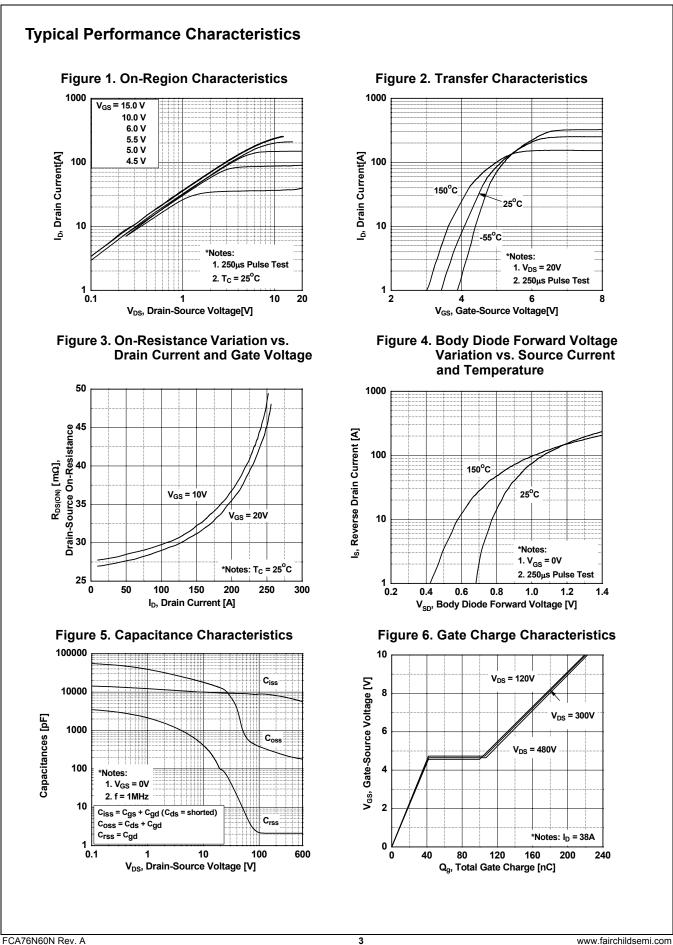
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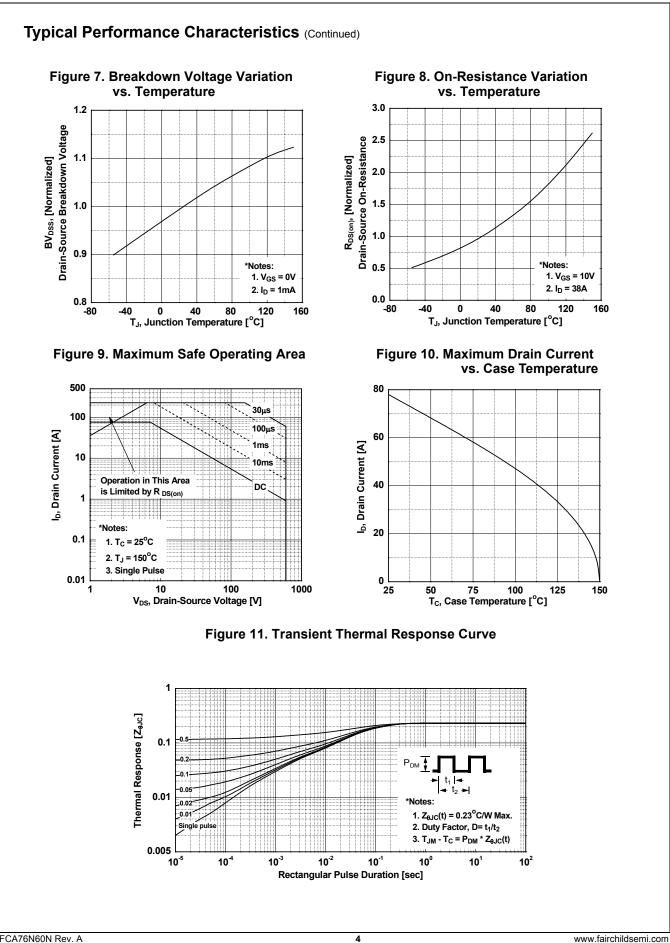
May 2010 SupreMOS[™]

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FCA76N Electrica		FCA76N60N	TO-3P	N					~ ~	
Electrica				11	-		-		30	
	i Unara	acteristics								
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristics	5					1		4	
BV _{DSS}	I	Source Breakdown \	/oltage	I _D = 1m	nA, V _{GS} = 0V,T _J = 25	5°C	600	-	-	V
∆BV _{DSS}		wn Voltage Tempera	-		A, Referenced to 25		_	0.73	_	V/ºC
ΔT_{J}	Coefficie	ent		_			-	0.75		v/ C
I _{DSS} Zero Gate Volt		te Voltage Drain Curr	oltage Drain Current		480V, V _{GS} = 0V		-	-	10	μA
	-			$180V, T_{J} = 125^{\circ}C$		-	-	100		
I _{GSS}	Gate to	Body Leakage Curre	nt	V _{GS} = :	±30V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristics	5								
V _{GS(th)}	Gate Th	reshold Voltage			V _{DS} , I _D = 250μA		2.0	-	4.0	V
R _{DS(on)}	Static Dr	rain to Source On Re	sistance	V _{GS} =	10V, I _D = 38A		-	28	36	mΩ
9 _{FS}	Forward	$V_{DS} = 40V, I_D = 38A$		-	88	-	S			
Dynamic C	haracte	ristics								
C _{iss}		pacitance		V _{DS} = 100V, V _{GS} = 0V		-	9310	12385	pF	
C _{oss}		Capacitance				-	370	495	pF	
C _{rss}		Transfer Capacitanc	e	f = 1M	Ηz	-	_	3.1	5.0	pF
C _{oss}		Capacitance	V _{DS} = 380V, V _{GS} = 0V, f = 1MHz		-	196	-	pF		
C _{oss} eff.		Output Capacitance			-	914	-	pF		
Q _{g(tot)}		te Charge at 10V		V _{DS} = 380V, I _D = 38A,		-	218	285	nC	
Q _{gs}		Source Gate Charge				-	39	-	nC	
Q _{gd}		Drain "Miller" Charge		V _{GS} =	10V		-	66	-	nC
ESR	Equivalent Series Resistance (G-S)		(Note 4) Drain Open, f=1MHz		_	1.0	-	Ω		
-			(00)	Diani				1.0		
Switching	-									
t _{d(on)}		Delay Time		V_{DD} = 380V, I_D = 38A R_G = 4.7 Ω		-	34	78	ns	
t _r		Rise Time				-	24	58	ns	
t _{d(off)}		Delay Time Fall Time					-	235	480	ns
t _f	Turn-Oil					(Note 4)	-	32	74	ns
Drain-Soui	rce Diod	e Characteristic	s							
Is	Maximur	n Continuous Drain te	o Source Diod	e Forwar	d Current		-	-	76	Α
I _{SM}	Maximur	n Pulsed Drain to So	urce Diode Fo	orward Current		-	-	228	Α	
V _{SD}	Drain to	Source Diode Forwar	rd Voltage	$V_{GS} = 0$	0V, I _{SD} = 38A		-	-	1.2	V
t _{rr}	Reverse	Recovery Time			0V, I _{SD} = 38A		-	613	-	ns
Q _{rr}	Reverse	Recovery Charge		dl _F /dt =	= 100A/μs		-	16	-	μC

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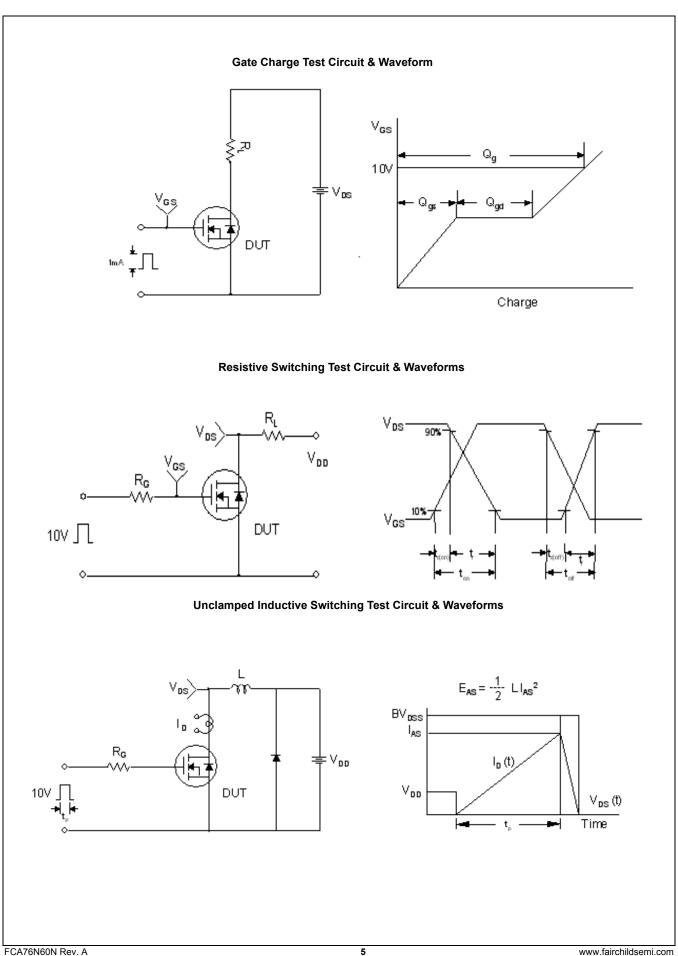




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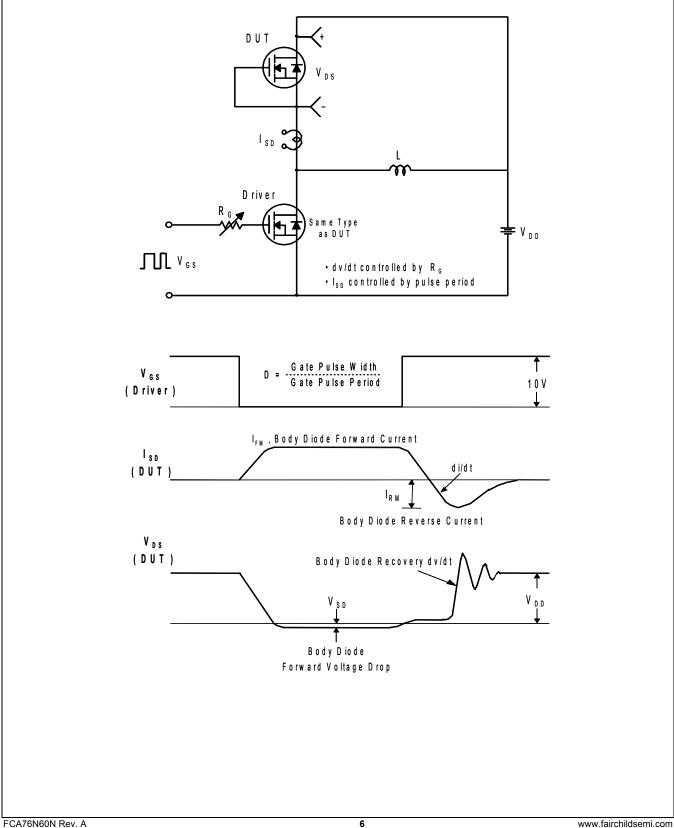
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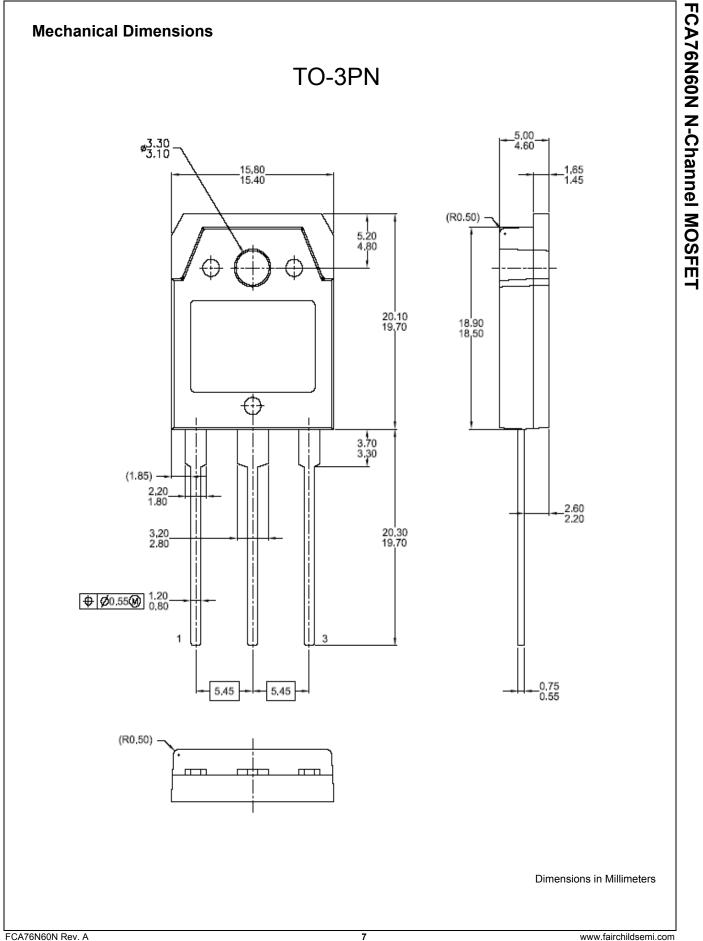
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Peak Diode Recovery dv/dt Test Circuit & Waveforms





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